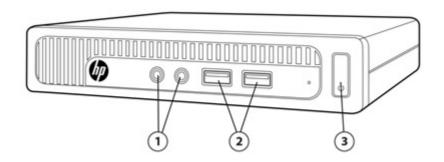
**Overview** 

## HP ProDesk 600 G1 Desktop Mini Business PC



- 1. 3.5mm headphone output and microphone jacks
- 2. (2) Front USB 3.0 ports
- 3. Power button and PC status LED

#### Not Shown

Slots (1) internal M.2 connector for optional wireless NIC

(1) internal M.2 connector for optional SSD drive (Available June '14)

Bays (1) 2.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (2) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

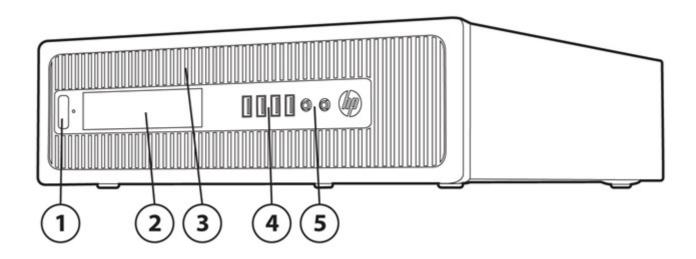
(1) RJ-45 network connector 3.5mm audio out jack

VESA Support for VESA 100mm mounting system on bottom of PC chassis



Overview

### HP ProDesk 600 G1 Small Form Factor Business PC



- 1. Power button and PC status LED
- 2. 3.5" external drive bay; used for installing a Media Card Reader or 2nd data storage drive
- 3. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 4. (2) USB 3.0 ports, (2) USB 2.0 ports
- 5. 3.5mm headphone output and microphone jack

#### Not Shown

Slots (1) PCI Express x16 graphics connector

(3) PCI Express x1 accessory connectors

Bays (1) 2.5" internal storage drive bay

(1) 3.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

(1) RS-232 serial port

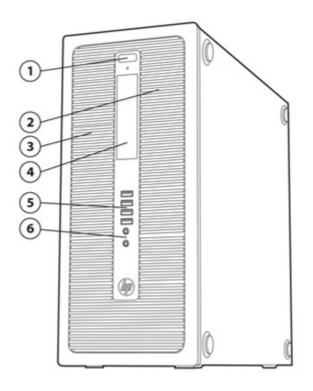
3.5mm audio in/out jacks

PS/2 keyboard and mouse ports



**Overview** 

### **HP ProDesk 600 G1 Tower Business PC**



- 1. Power button and PC status LED
- 2. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 3. 5.25" half height external drive bay (located behind removable bezel)
- 4. 3.5" external drive bay; used for installing a Media Card Reader
- 5. (2) USB 3.0 ports, (2) USB 2.0 ports
- 6. 3.5mm headphone output and microphone jack

#### Not Shown

Slots (1) PCI Express x16 graphics connector

(3) PCI Express x1 accessory connector

Bays (1) 2.5" internal storage drive bay

(2) 3.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

(1) RS-232 serial port

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports



### **Overview**

#### At A Glance

- Choice of Desktop Mini, Small Form Factor or Tower chassis options
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel® Q85 chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics and Intel® Standard Manageability Technology
- Intel® Ethernet Connection I217L GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- Discrete graphics options available for SFF and TWR platforms
- DTS+ Sound audio management software
- Standard and high efficiency energy saving power supply options
- ENERGY STAR® qualified and certified EPEAT® Gold models
- Guaranteed lengthy purchase lifecycles and image stability



Standard Features and Configurable Components (availability may vary by country)

#### **OPERATING SYSTEM**

Preinstalled When Purchased Windows 8.1 Pro (64-bit)\* Windows 8.1 (64-bit)\*

Windows 7 Ultimate (32-bit)\*\*
Windows 7 Ultimate (64-bit)\*\*
Windows 7 Professional (32-bit)\*\*

Windows 7 Professional (64-bit)\*\*

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)\*\*\*
Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)\*\*\*

Windows 7 Home Premium (32-bit)\*\*
Windows 7 Home Premium (64-bit)\*\*

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

\*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

\*\*Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See <a href="http://www.microsoft.com/windows/windows-7">http://www.microsoft.com/windows/windows-7</a>/ for details.

\*\*\*This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

#### **CHIPSET**

	DM	SFF/TWR
Intel® Q85 Express	X	X

#### **PROCESSOR**

	DM	SFF/TWR
Intel® 4th Generation Core™ i7 Processors		
Intel® Core™ i7-4765T Processor	X	
Up to 3.0 GHz Max. Turbo Frequency (2.0 GHz base frequency)		
8 MB cache, 4 cores, 8 threads		
Intel HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Core™ i7-4770 Processor		X
Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency)		
8 MB cache, 4 cores, 8 threads		
Intel HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		



Standard Features and Configurable Components (availability may vary by country)

X Intel Core i7-4771 Processor Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Intel® 4th Generation Core™ i5 Processors Intel® Core™ i5-4570 Processor X Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Intel® Core™ i5-4570T Processor X Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Intel® Core™ i5-4670 Processor X Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Intel® 4th Generation Core™ i3 Processors Intel® Core™ i3-4130 Processor X Up to 3.4 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate Intel® Core™ i3-4130T Processor X 2.9 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate Intel® Core™ i3-4330 Processor X Up to 3.5 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Intel® Core™ i3-4330T Processor X 3.0 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate X Intel® Core™ i3-4340 Processor Up to 3.6 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate



Intel® 4th Generation Pentium™ Processors

Standard Features and Configurable Components (availability may vary by country)

Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency		X
3 MB cache, 2 cores, 2 threads Intel HD Graphics		
Supports DDR3 memory up to 1333 MT/s data rate		
Intel® Pentium™ G3220T Processor 2.6 GHz base frequency	X	
3 MB cache, 2 cores, 2 threads		
Intel HD Graphics		
Supports DDR3 memory up to 1333 MT/s data rate		
Intel® Pentium G3420 Processor		X
Up to 3.2 GHz base frequency		
3 MB cache, 2 cores, 2 threads		
Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		
	v	
Intel® Pentium™ G3420T Processor 2.7 GHz base frequency	X	
3 MB cache, 2 cores, 2 threads		
Intel HD Graphics		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Pentium G3430 Processor		X
Up to 3.3 GHz base frequency		
3 MB cache, 2 cores, 2 threads		
Intel HD Graphics		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® 4th Generation Celeron™ Processors		
Intel® Celeron™ G1820 Processor		X
2.7 GHz base frequency		
2 MB cache, 2 cores, 2 threads		
Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate		
Available February '14		
Intel® Celeron™ G1820T Processor	X	
2.4 GHz base frequency		
2 MB cache, 2 cores, 2 threads		
Intel HD Graphics		
Supports DDR3 memory up to 1333 MT/s data rate		
Intel® Celeron™ G1830 Processor		X
2.8 GHz base frequency		
2 MB cache, 2 cores, 2 threads Intel HD Graphics		
Supports DDR3 memory up to 1333 MT/s data rate		
Available February '14		



# **QuickSpecs**

Standard Features and Configurable Components (availability may vary by country)

## **GRAPHICS**

	DM	SFF/TWR
Intel HD Graphics on all models (integrated on processor)	х	Х
Optional Discrete Graphics Solutions		
AMD Radeon HD 8350 (1GB) PCIe x16		X
AMD Radeon HD 8490 (1GB) PCIe x 16		X
NVIDIA NVS 310 (512 MB) PCIe x16		X
NVIDIA NVS 315 (1GB) PCIe x 16		X
NVIDIA GeForce GT630 (2 GB) FH PCIe x16		TWR only
Adapters and Cables		
HP DMS-59 to Dual DisplayPort Cable		X
HP DMS-59 to Dual DVI Cable		X
HP DMS-59 to Dual VGA Cable		X
HP DisplayPort to DisplayPort Cable	X	X
HP DisplayPort to DVI-D Adapter	X	X
HP DisplayPort to HDMI Adapter	X	X
HP DisplayPort to VGA Adapter	X	X
HP Serial Port Adapter		X
HP Parallel Port Adapter		X
STORAGE		
Hard Disk Drive (HDD)	DM	SFF/TWR
320 GB 7200 rpm HDD		X
500 GB 7200 rpm HDD	X	X
500 GB 7200 rpm SED HDD	X	X
500 GB 10K rpm HDD		X
1 TB 7200 rpm HDD		X
1 TB 10K rpm HDD		X
2 TB 7200 rpm HDD		X
Solid State Hybrid Drives (SSHD)		
500 GB SSHD (8 GB cache)	X	X
1 TB SSHD (8 GB cache)	X	X
Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)		
120 GB Opal SED	X	X
128 GB SSD		X
128 GB Opal SED	X	X



## Standard Features and Configurable Components (availability may vary by country)

128 GB M.2 PCle SSD	X	
160 GB SSD		X
180 GB Opal SED	X	X
256 GB SED		X
256 GB Opal SED	X	X
Optical Disc Drives		
Slim DVD-ROM		X
Slim BDXL Blu-ray Writer		X
Slim SuperMulti DVD Writer		X
HH Supermulti ODD		TWR only
Removable		
HP Slim Removable SATA HDD Frame/Carrier		x

### **MEMORY**

Form Factor	Туре	Maximum	# of Slots
Desktop Mini	DDR3 non-ECC up to 1600 MT/s	16 GB	2 SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM
Tower	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

## **NETWORKING/COMMUNICATIONS**

Ethernet (RJ-45)	DM	SFF/TWR
Intel I217LM Gigabit Network Connection (standard)	X	X
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)		X
Wireless		
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express x1 Wireless Network Connection (optional)		X
Intel Wireless-N 7260 802.11 M.2 a/b/g/n NIC Card Wireless Network Connection (optional)	X	
Intel Wireless-N 7260 802.11 a/b/g/n PCIe x1 NIC Wireless Network Connection (optional)		X



Standard Features and Configurable Components (availability may vary by country)

## **AUDIO/MULTIMEDIA**

Audio	DM	SFF/TWR
HD audio with Realtek ALC221 codec (all ports are stereo)	x	X
DTS Sound + audio management technology	x	X
Microphone* and headphone front ports (3.5mm)	x	X
Line-out and Line-In rear Ports* (3.5mm)	Line out only	X
Multi-streaming capable*	x	X
Internal speaker (standard)	х	X

<sup>\*</sup> The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

### **KEYBOARDS AND POINTING DEVICES**

Keyboard	DM	SFF/TWR
HP PS/2 Keyboard		X
HP USB Keyboard	X	X
USB Smart Card (CCID) Keyboard	X	X
HP USB and PS/2 Washable Keyboard	X	X
HP Wireless Keyboard and Mouse Combo*	X	X
*Keyboard contains 25% post-consumer recycled plastic material.		
Mice		
HP PS/2 Mouse		X
HP USB Mouse	X	X
HP USB 1000dpi Laser Mouse	X	X
HP USB and PS/2 Washable Mouse	X	X



Standard Features and Configurable Components (availability may vary by country)

### **HP BIOS**

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP ProDesk 600 G1 Series Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
  component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in
  any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS
  updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe
  recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise;
  it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

#### Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
  configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be
  made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
  management, allowing operating systems and applications to manage power based on activity and usage. HP Elite models
  use ACPI to provide power conservation features.

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.



Standard Features and Configurable Components (availability may vary by country)

### **SECURITY**

	DM	SFF/TWR
Trusted Platform Module (TPM) 1.2	X	X
SATA port disablement (via BIOS)	X	X
Drive lock	X	X
Intel® Identify Protection Technology (IPT) <sup>1</sup>	X	X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
HP Chassis (1 bay) Security Kit		TWR only
Solenoid Hood Lock / Sensor		X
Support for chassis padlocks and cable lock devices	X	X

<sup>1</sup>Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module

### **ENVIRONMENTAL & REGULATORY**

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Low halogen (chassis, all internal components and modules)

TAA compliant

### **PORTS**

I/O Ports - Standard	DM	SFF/TWR
VGA video port	1 (rear)	1 (rear)
DisplayPort with multi-stream video ports	2 (rear)	2 (rear)
USB 2.0	2 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	1
PS/2	N/A	1 keyboard (purple) 1 mouse (green)
Audio	<ul><li>3.5mm headphone &amp; microphone jack (front)</li><li>3.5mm audio out jack (rear)</li></ul>	<ul><li>3.5mm headphone &amp; microphone jack (front)</li><li>3.5mm audio in &amp; out jacks (rear)</li></ul>
Network Interface	1 RJ-45	1 RJ-45
I/O Ports - Optional	DM	SFF/TWR
2nd Serial (RS-232)	N/A	1



Standard Features and Configurable Components (availability may vary by country)

Parallel	N/A	1

#### **SLOTS**

	DM	SFF/TWR
PCI Express x1	N/A	3
PCI Express x16	N/A	1
M.2	1 ea. M.2-2230 (for WLAN) 1 ea. M.2-2280 (for storage drives)	N/A

### **BAYS**

	DM	SFF/TWR
Media Card Reader	N/A	1
Slim Optical Disc Drive	N/A	1
3.5" internal storage drive	N/A	1 - SFF 1 - TWR
2.5" internal storage drive	1	1

### **SERVICE AND SUPPORT**

On-site Warranty <sup>1</sup>: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day <sup>2</sup> service for parts and labor and includes free telephone support <sup>3</sup> 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

**NOTE 1:** Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

**NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

**NOTE 3:** Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



Technical Specifications – Operating Systems, Software and eDocumentation

#### **OPERATING SYSTEMS**

Preinstalled Windows 8.1 Pro (64-bit)\*

Windows 8.1 (64-bit)\*

Windows 7 Ultimate (32-bit)\*\*
Windows 7 Ultimate (64-bit)\*\*
Windows 7 Professional (32-bit)\*\*
Windows 7 Professional (64-bit)\*\*

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)\*\*\* Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)\*\*\*

Windows 7 Home Premium (32-bit)\*\*
Windows 7 Home Premium (64-bit)\*\*

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

For all Preinstalled operating systems HP provides Microsoft WHQL certified (where applicable) drivers on www.hp.com at the time of product announcement.

**Web Support** Windows 7 Enterprise (32-bit or 64-bit)

Windows 8 (64-bit)
Windows 8 Pro (64-bit)\*
Windows 8 Enterprise (64-bit)\*\*

For all Supported operating systems HP performs testing of the OS, and makes available all HP value add software (OS dependent). Certified drivers are made available on www.hp.com within 30 days of product announcement.

**Certified** Novell SUSE Linux Enterprise Desktop 11<sup>1</sup>

Red Hat Enterprise Linux 641

For all Certified operating systems HP will submit hardware to the operating system vendor for testing and certification. All drivers would be obtained from the operating system vendor, not supplied by HP. Certification will be posted by the operating system vendor.

**Test & Document** Windows® Vista Enterprise (32-bit or 64-bit)

Windows® Vista Professional (32-bit or 64-bit)

For all Test & Document operating systems HP will perform functional testing of the operating system on the HP business PC platform. Any issues found will be documented in an Engineering Advisory and/or Service Advisory and posted to www.hp.com. HP will not develop or qualify any drivers or perform any integration testing.

\*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

\*\*Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for details.

\*\*\*This system is preinstalled with Windows® 7 Professional software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

<sup>1</sup>The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus
- HP 16-in-1 Media Card Reader
- HP Client Security



## Technical Specifications – Operating Systems, Software and eDocumentation

- HP Blu-ray Writer playback of commercial movies
- DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

The following features are not supported by Red Hat Enterprise Linux 64:

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP 16-in-1 Media Card Reader
- HP Blu-ray Writer
- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

### SSOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Included	Windows 7	Windows 8.1
Security	Absolute Persistence (status tracing) <sup>1</sup> Device Access Manager Drive Encryption <sup>4</sup> File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) <sup>2</sup> Microsoft Security Essentials HP Client Security	Absolute Persistence (status tracing) <sup>1</sup> Device Access Manager Drive Encryption <sup>4</sup> File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) <sup>2</sup> Microsoft Defender Secure Erase HP Client Security
MultiMedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver <sup>3</sup> HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver <sup>1</sup> HP PageLift HP Recovery Manager HP Support Assistant HP QuickStart
3rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box PDF Complete, Corporate Edition Skype	Bing Search PDF Complete, Corporate Edition Skype
Microsoft Products	Buy Office	Buy Office

<sup>&</sup>lt;sup>1</sup> Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.

<sup>&</sup>lt;sup>2</sup> Available via download



## **HP ProDesk 600 G1 Business Series Desktop**

## Technical Specifications – Operating Systems, Software and eDocumentation

<sup>3</sup> Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see <a href="https://www.hp.com/go/eprintcenter">www.hp.com/go/eprintcenter</a>). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary

<sup>4</sup> Drive Encryption is planned to be available in October 2013. Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.



### **Technical Specifications - Graphics**

## **Intel HD Graphics**

VGA Controller Integrated

DisplayPort Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream

Technology for a maximum of 3 displays (including the integrated panel)

Bus Type N/A RAMDAC N/A

**Memory** Intel graphics do not have dedicated memory but utilizes some of the computer's system memory

The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio

Video Playback) support for playback of protected video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Maximum Graphics MemoryMicrosoft Windows 7Windows 8.1

Up to 1.7GB Up to 1.8GB

**NOTE:** The actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

Maximum Color Depth 32 bits/pixel

**Graphics/Video API Support** 4th Generation Core processors:

- The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
- Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
  - Encode/transcode HD content
  - Playback of high definition content including Blu-ray Disc
  - O Superior image quality with sharper, more colorful images
- DirectX Video Acceleration (DXVA) support for accelerating video processing
  - Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 7, Windows 8, Linux OS Support
- DirectX 11.1
- OpenGL 4.0
- Open CL 1.2

#### **Supported Display Resolutions and Refresh Rates**



## **Technical Specifications - Graphics**

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz

<sup>\*</sup> Only supported on displays connected to the external DisplayPort connector.

## AMD Radeon HD 7650A Graphics Card

Form Factor MXM 3.0

Graphics Controller AMD Radeon HD 7650A

Core Clock 600MHz Memory Clock 800MHz

Memory 2GB, DDR3, 128-bit wide

**Bus Type** MXM **Max. Power** 35W

Power Source Support 12V and 19V 3D API Support DX11, SMS

**HDCP Support** Yes

**Display Max. Resolution**Digital 2560 x 1600
Analog 2048 x 1536

**Supported Graphics APIs** DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort support



### **Technical Specifications - Graphics**

#### **Supported Display Resolutions and Refresh Rates**

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
800 x 600	60 Hz
1024 x 768	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 1024	60 Hz
1360 x 768	60 Hz
1440 x 900	60 Hz
1600 x 900	60 Hz
1680 x 1050	60 Hz
1920 x 1080	60 Hz

### **NVIDIA NVS 310 Graphics Card**

**Introduction** The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics add-in card

targeted as an active low cost graphics solution for the corporate business and enterprise markets.

The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor

graphics add-in card for either standard or small form factor PC designs.

Performance and Features The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is capable of

supporting up to 2 displays.

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI

monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.

**Form Factor** Low Profile: 2.713 × 6.15 in

**Graphics Controller** NVIDIA® NVS 310

Memory Clock875MHzMemory Size512 MB DDR3Memory Bandwidth14 GB/sMax. Power19.5W

**Display Max. Resolution**Up to 2560 x 1600 (digital display) per display **Display Output**Up to 2 displays in the following configurations

op to 2 displays in the following configurations

DisplayPort output:

• Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card

 Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology.



## **Technical Specifications - Graphics**

**DVI-D** output:

Drives two digital display at resolutions up to 1920 × 1200 at 60
Hz with reduced blanking using DisplayPort to DVI-D single-link
cable adaptors

 Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

**HDMI** output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

Drives two analog display at resolutions up to 1920 x 1200 at 60
 Hz using DisplayPort to VGA cable adaptors

### **Supported Display Resolutions and Refresh Rates**

Resolution	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60



### **Technical Specifications - Graphics**

### **NVIDIA GeForce GT630 Graphics Card**

Introduction The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed

to support three display connections through its DVII, and two DisplayPort connectors.

An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics

and excellent visual display quality.

**Performance and Features** 

The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:

Unprecedented flexibility for new applications and enhanced performance

Support for NVIDIA surround technology

• Run multiple displays from a single graphics card

• Full 16 lane PCIe Generation 3 bus support with peak bandwidth support

Wireless Display ready for future support

**Form Factor** PCIe x16 Card

**Graphics Controller NVIDIA Kepler Architecture GPU** 

**Core Clock** 875 MHz **Memory Clock** 891 MHz

**Memory Size** 2 GB DDR3 128 bit

**Memory Bandwidth** 28.5 GB/s

**Display Max. Resolution** 2560 x 1600 digital, 2048 x 1536 analog

**Display Output** Integrated 400 MHz RAMDAC

#### **Supported Display Resolutions and Refresh Rates**

Resolution	Maximum Refr	esh Rates (Hz)
	Analog Connection	Digital Connection
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60



**Technical Specifications - Graphics** 

2560 x 1600 N/A 60

### **NVIDIA NVS 315 1GB PCIe x 16 Graphics Card**

**Introduction** Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the

NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional

business and commercial applications.

Performance and Features The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of

supporting up to 2 displays.

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI

monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.

**Form Factor** Low Profile: 2.713 × 6.15 in

**Graphics Controller** NVIDIA® NVS 315

Memory Clock875MHzMemory Size512 MB DDR3Memory Bandwidth14 GB/s

Connectors DMS-59, with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable

**Display Max. Resolution** Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort

**Display Output** Up to 2 displays in the following configurations

#### **Supported Display Resolutions and Refresh Rates**

Resolution Maximum Ref		fresh Rates (Hz) by Connection	
	Analog Connection	Digital Connection	
640 x 480	85	60	
720 x 480	85	60	
720 x 576	85	60	
800 x 600	85	60	
1024 x 768	85	60	
1280 x 720	85	60	
1280 x 768	85	60	
1280 x 1024	85	60	
1440 x 900	75	60	
1600 x 1024	85	60	
1600 x 1200	85	60	
1680 x 1050	75	60	
1920 x 1080	85	60-R	
1920 x 1200	85	60-R	
1920 x 1440	85	N/A	
2048 x 1536	75	N/A	



### **Technical Specifications - Graphics**

2560 x 1440 N/A 60\* 2560 x 1600 N/A 60\*

\* Display Port Only

## AMD Radeon HD 8350 1GB PCie x16 DH Graphics Card

Introduction Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCIe x16

DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD

8350 GPU, great for Web conferencing or video and photo editing.

Form Factor PCie x16

Graphics Controller AMD Radeon HD 8350

**Core Clock** GPU engine operates at 523 MHz

Memory 1GB, DDR3, SDRAM

Memory Clock875 MHzHDCP SupportYes

**Display Max. Resolution** Digital 1920 x 1200

Analog 2048 x 1536

#### **Supported Display Resolutions and Refresh Rates**

Analog Connection	Digital Connection
85	60
85	60
85	60
85	60
85	60
85	60
85	60
85	60
75	75
85	60
85	60
75	75-R
85	60-R
85	60-R
85	N/A
75	N/A
N/A	N/A
N/A	N/A
	85 85 85 85 85 85 85 85 75 85 85 75 85 85 85



### **Technical Specifications - Graphics**

## AMD Radeon HD 8490 1GB PCie x16 Graphics Card

**Introduction** Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express

x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your

everyday PC, Web conferencing, and video or photo editing.

Form Factor PCie x16

**Graphics Controller** AMD Radeon HD 8490

**Core Clock** GPU engine operates at 875 MHz

Memory 1GB, DDR3, SDRAM

Memory Clock 900 MHz
HDCP Support Yes

**Display Max. Resolution** Digital 2560 x 1600

Analog 2048 x 1536

### **Supported Display Resolutions and Refresh Rates**

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60



### **HP ProDesk 600 G1 Business Series Desktop**

Technical Specifications - Hard Disk and Solid State Storage

### **Introduction:**

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP ProDesk 600 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

#### **HP Drive Lock**

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

### **SMART IV Technology**

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

#### **Native Command Queuing**

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

**NOTE:** GB = 1 billion bytes. Actual available capacity is less.



Technical Specifications - Hard Disk and Solid State Storage

## HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive

**Capacity** 500,107,862,016 bytes

**Rotational Speed** 7,200 rpm

**Drive Type** Self-Encrypting Drive (SED) with SATA interface

Interface SATA Interface conforming to Serial ATA International Organization: Serial ATA Revision 2.6

Segmented Buffer with write

cache

32768 KB - A portion of buffer capacity used for firmware

**Number of Sectors** 976,773,168

Single Track: 1.0 ms

**Seek Time (typical reads)** Average: 13 ms

Full-Stroke 25 ms

Media Diameter 2.5 in/63.5 mm

 Height
 0.267 in/6.8 mm, ±0.2mm

 Width
 2.75 in/69.85 mm, ±0.25mm

 Length
 3.945 in/100.2 mm, ±0.25mm

**Weight** 3.35 oz/95 g (max)

**Operating Temperature** 32° to 140° F (0° to 60° C)

## HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 1 TB

**Spindle Speed** 5,400 rpm +/- 0.2%

**Drive Type** Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface Serial ATA (SATA)

**Cache Buffer** 64 MB **NAND Flash Commercial** 8 GB

Multilevel Cell (cMLC)

Number of Sectors 976,773,168

Seek Time (typical reads) Single Track: 2.0 ms

Average: 12 ms

**Height** 0.374 +/-.008 in (9.5 +/- 0.2 mm)

Width 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

**Length** 3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)

 Weight
 0.254 lb/115 g (max)

 Operating Temperature
 32° to 140° F (0° to 60° C)



Technical Specifications - Hard Disk and Solid State Storage

## HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 500 GB

**Spindle Speed** 5,400 rpm +/- 0.2%

**Drive Type** Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface Serial ATA (SATA)

**Cache Buffer** 64 MB **NAND Flash Commercial** 8 GB

Multilevel Cell (cMLC)

**Number of Sectors** 976,773,168

Seek Time (typical reads) Single Track: 2.0 ms

Average: 12 ms

**Height** 0.268 +/-.008 in (6.8 +/- 0.2 mm) **Width** 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

**Length** 3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)

Weight 0.209 lb/95 g (max)

Operating Temperature 32° to 140° F (0° to 60° C)

### **HP 120 GB Solid State Drive**

**Unformatted Capacity** 120 GB

Architecture Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller

Interface Serial ATA 2.0 (3.0 Gb/s)

**Dimensions (W x H x D)** 2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)

**Weight** 0.18 lb (80 g)

**Bandwidth Performance** Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s
Random Read: Up to 35K IOPs
Random Write: Up to 6.6K IOPs

**Latency** Read: 65-ms

Write: 85-ms

**Power** DC power requirement: 5 VDC 5%-100 mV ripple p-p

Total power consumption: 0.15W (active); 0.075W (idle)

**Useful Drive Life** 35TB written, up to 20GB/day for 5 years

**Environmental** Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-condensing) Relative Humidity: 5% to 95%

Maximum Wet Bulb 84° F (29° C)

Temperature (operating):

Shock: 1,500 G/0.5-ms

<sup>\*\*</sup> The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.



<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

Latency

## Technical Specifications - Hard Disk and Solid State Storage

#### **HP 128 GB Solid State Drive**

**Unformatted Capacity** 128 GB\*

Architecture Multi Level Cell (MLC) NAND

Interface SATA 6 GB/sec

**Dimensions (W x H x D)** 2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)

**Weight** 0.16 lb (73 g)

**Bandwidth Performance** Sustained Sequential Read: Up to 450 MB/ss

Sustained Sequential Write: Up to 260 MB/s
Random Read (4KB): up to 46K IOPs
Random Write (4KB): up to 56K IOPs
Read: 55ms (TYP)

Write: 55ms (TYP)

**Power** DC power requirement: Min 4.5 V; Max 5.5 V

Total power consumption: 160 mW (Active); <85 mW; (Idle)

**Useful Drive Life** 1.2 million device hours\*\*

**Environmental** Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-condensing) Relative Humidity (operating): 5% to 95%

Shock: 1,500 G/1.0 msec

**Regulations** UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS

CISPR 22:2002 Class B, Korea KCC, CE Mark

#### **HP 160 GB Solid State Drive**

**Unformatted Capacity** 160 GB\*

Architecture Multi Level Cell (MLC) NAND

Interface SATA 3 GB/sec

**Dimensions (W x H x D)** 2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)

**Weight** 0.18 lb (80 g)

**Bandwidth Performance** Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s
Random Read (4KB): up to 35K IOPs
Random Write (4KB): up to 6.6K IOPs

**Latency** Read: 65 ms

Write: 85 ms

**Power** DC power requirement: 5 VDC 5%-100 mV ripple p-p

Total power consumption: 0.15 Watt (Active); 0.075 Watt (Idle)

**Useful Drive Life** 35TB written, up to 20GB/day for 5 years \*\*



<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

<sup>\*\*</sup> The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

### Technical Specifications - Hard Disk and Solid State Storage

**Environmental** Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-condensing) Relative Humidity (operating): 5% to 95%

Shock: 1,500 G/1.0 msec

Regulations UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea

KCC, CE Mark

## HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive

**Unformatted Capacity** 256,186,209,271 bytes

Architecture Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface

InterfaceSerial ATA 2.0 (3.0 Gb/s)NAND Flash25nm MLC NAND Flash

 Height
 .275 in/7mm

 Width
 2.75 in/69.85 mm

 Length
 3.95 in/100.5 mm

 Weight
 0.161 lb (73 g)

**Bandwidth Performance** Sustained Sequential 128k Read: Up to 450 MB/ss

Sustained Sequential 128k Write: Up to 260 MB/s
Random 4k Read: up to 46K IOPs
Random 4k Write: up to 56K IOPs

**Latency** Read: 55 μs

Write: 55 μs

**Power** SATA power consumption: 160 mW (active average); <85 mW (idle average)

**Useful Drive Life** 72TB written, up to 40GB/day for 5 years

**Environmental** Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-condensing) Relative Humidity: 5% to 95%

Shock: 1,500 G/1 ms



<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

<sup>\*\*</sup> The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications - Hard Disk and Solid State Storage

## HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

**Capacity** 500,107,862,016 bytes

**Rotational Speed** 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

**Buffer Size** 16 MB

**Logical Blocks** 976,773,168

Seek Time (typical reads,<br/>includes controller overhead,<br/>including settling)Single Track:<br/>Average:<br/>Full-Stroke:2.0 ms<br/>11 ms<br/>21 ms

Height (nominal) 1 in/2.54 cm

Width (nominal) Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

**Operating Temperature** 41° to 131° F (5° to 55° C)

## HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

**Capacity** 1,000,204,886,016 bytes

**Rotational Speed** 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 32 MB

**Logical Blocks** 1,953,525,168

Seek Time (typical reads,<br/>includes controller overhead,<br/>including settling)Single Track:<br/>Average:2.0 msAverage:<br/>Full-Stroke:11 ms21 ms

Height (nominal) 1 in/2.54 cm

Width (nominal) Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

**Operating Temperature** 41° to 131° F (5° to 55° C)



Technical Specifications - Hard Disk and Solid State Storage

## HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Unformatted Capacity 2 TB

Rotational Speed 7,200 rpm

Interface SATA 6Gb/s NCQ

Cache, Multisegmented (MB) 64 MB

**Seek Time** (average) Read <8.5 ms

Write <9.5 ms

 Height
 1.028 in/26.11 mm

 Width
 4.0 in/101.6 mm

 Depth
 5.787 in/146.99 mm

**Weight** 1.38 lb/626 g

**Operating Temperature** 32° to 140° F (0° to 60° C)



## Technical Specifications - Removable Storage

### **HP Slim SuperMulti DVD Writer Drive**

**Height** 12.7mm height

**Orientation** Either horizontal or vertical

Interface type SATA/ATAPI

**Disc recording capacity** Up to 8.5 GB DL or 4.7 GB standard

**Dimensions** (W x H x D) 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

**Weight** (max) 0.42 lb (190 g)

DVD-RAM Up to 5X

DVD-R DL Up to 6X

DVD+R Up to 8X

DVD+RW Up to 8X

Write speeds DVD+R DL Up to 6X

DVD-R Up to 8X

DVD-RW Up to 6X

CD-R Up to 24X

CD-RW Up to 24X

DVD-RAM Up to 5X

DVD-RW, DVD+RW Up to 8X

DVD-R DL, DVD+R DL Up to 8X

**Read speeds** DVD+R, DVD-R Up to 8X

DVD-ROM DL, DVD-ROM Up to 8X

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

Access time DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

(typical reads, including Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

Stop Time 6 seconds (typical)

Source Slimline SATA DC power receptacle

**Power** DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)



settling)

Quadruple-layer

# QuickSpecs

## **Technical Specifications - Removable Storage**

Temperature 41° to 122° F (5° to 50° C)

Triple-layer

**Environmental conditions** (operating - non-condensing)

Relative Humidity 10% to 80%

Maximum Wet Bulb 84° F (29° C)

Temperature

## **HP Slim Blu-ray BDXL Drive**

Height12.7mm Slim tray-loadOrientationEither horizontal or vertical

Interface type SATA/ATAPI

**Disc capacity** Up to 128 GB QL, 100 GB TL, 50 GB DL or 25 GB standard SL **Dimensions** 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

W x H x D (max)

**Write speeds** 

Weight (max) Up to 0.37 lb (170 g) without bezel

	•	
BD-R	Up to 4x	Up to 4x
BD-RE	Up to 2x	Not supported
	Single-layer	Double-layer
BD-R	Up to 6x	Up to 6x
BD-RE	Up to 2x	Up to 2x
DVD-R	Up to 8x	Up to 6x
DVD-RW	Up to 6x	Not supported
DVD+R	Up to 8x	Up to 6x
DVD+RW	Up to 8x	Not supported
DVD-RAM	Up to 5x	N/A
CD-R	Up to 24x	N/A
	Up to 24x	N/A
CD-RW	υ <b>ρ</b> το 24χ	IN/A
CD-RW	Triple-layer	Quadruple-layer
CD-RW BD-R	•	-
	Triple-layer	Quadruple-layer
BD-R	<b>Triple-layer</b> Up to 4x	<b>Quadruple-layer</b> Up to 4x
BD-R	Triple-layer Up to 4x Up to 4x	<b>Quadruple-layer</b> Up to 4x Not supported
BD-R BD-RE	Triple-layer Up to 4x Up to 4x Single-layer	Quadruple-layer Up to 4x Not supported Double-layer
BD-R BD-RE BD-ROM	Triple-layer Up to 4x Up to 4x Single-layer Up to 6X	Quadruple-layer Up to 4x Not supported Double-layer Up to 6X
BD-R BD-RE BD-ROM BD-R	Triple-layer Up to 4x Up to 4x Single-layer Up to 6X Up to 6x	Quadruple-layer Up to 4x Not supported Double-layer Up to 6X Up to 6x
BD-R BD-RE BD-ROM BD-R BD-RE	Triple-layer Up to 4x Up to 4x Single-layer Up to 6X Up to 6x Up to 6x	Quadruple-layer Up to 4x Not supported Double-layer Up to 6X Up to 6x Up to 6x
BD-R BD-RE BD-ROM BD-R BD-RE DVD-ROM	Triple-layer Up to 4x Up to 4x Single-layer Up to 6X Up to 6x Up to 6x Up to 8x	Quadruple-layer Up to 4x Not supported Double-layer Up to 6X Up to 6x Up to 6x Up to 8x
BD-R BD-RE BD-ROM BD-R BD-RE DVD-ROM DVD-R	Triple-layer Up to 4x Up to 4x Single-layer Up to 6X Up to 6x Up to 6x Up to 8x Up to 8x	Quadruple-layer Up to 4x Not supported Double-layer Up to 6X Up to 6x Up to 6x Up to 8x Up to 8x



**Read speeds** 

(typical reads, including

setting)

## Technical Specifications - Removable Storage

**BDMV (AACS Compliant** 

Disc)

Up to 6x/2x (Read/Play)

**DVD-RAM** Up to 5x

**DVD-Video (CSS** Up to 8x/4x (Read/Play)

**Compliant Disc)** 

CD-R/RW/ROM Up to 24x

CD-DA (DAE) Up to 20x/10x (Read/Play)

**Access times** Random BD-ROM: 205 ms (typical), DVD-ROM: 185 ms (typical),

CD-ROM: 165 ms (typical)

**Full Stroke** BD-ROM: 350 ms (typical), DVD-ROM: 345 ms (typical),

CD-ROM: 340 ms (typical)

**Power** Source Slimline SATA DC power receptacle

> **DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

5 VDC -1200 mA typical, 2000 mA maximum **DC Current** 

**Environmental Temperature** (operating) 41° to 122° F (5° to 50° C)

(all conditions **Relative Humidity** 

non-condensing) (operating) 10% to 80%

**Maximum Wet Bulb** 

84° F (29° C)

Temperature (operating)

### **HP Slim DVD-ROM Drive**

Height 12.7mm

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Dimensions (W x H x D) 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

Weight (max) Up to 0.37 lb (170 g) without bezel

> DVD+R/-R/+RW/ Up to 8X

-RW/+R DL /-R DL

DVD-ROM Up to 8X Read speeds

> CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

**Access time** Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

(typical reads, including

**Full Stroke** DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical) settling)

> Source Slimline SATA DC power receptacle

**Power DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

> **DC Current** 5 VDC - <1000 mA typical, < 1600 mA maximum

Technical Specifications - Removable Storage

Temperature

41° to 122° F (5° to 50° C)

**Environmental** (all conditions non-condensing)

Relative Humidity

Maximum Wet Bulb Temperature (operating) 10% to 80%

84° F (29° C)



Technical Specifications – Memory

## **System Memory Support**

The HP ProDesk 600 G1 Business PC supports the 4th generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
  - 21.3 GB/s in dual-channel mode assuming 1333 MT/s
  - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

## **Platform Memory Support**

- The Small Form Factor (SFF) and Tower (TWR) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Desktop Mini platform supports up to two (2) industry-standard DDR3-SDRAM SODIMMs.

**CAUTION:** You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



## Technical Specifications - Networking and Communications

## Intel® I217LM GbE Network Connection (integrated)

**Connector** RJ-45

System Interface Integrated on PCA

Controller Intel I217LM GbE platform LAN connect networking controller

**Memory** 24 KB FIFO packet buffer memory

**Data rates supported** 10/100/1000 Mbps

802.1P 802.1Q 802.2

IEEE Compliance 802.3

802.3ab 802.3az 802.3u

**Bus architecture** PCI Express and SMBus

**Data transfer mode** PCIe-based interface for active state operation (SO state) and SMBus for host and management

traffic (Sx low power state)

**Power requirement** Requires 3.3V and 0.9V or just 3.3V with integrated regulators

Power consumption 0.733 Watts

**Boot ROM support** Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

**Network transfer rate** 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

**Environmental** Operating Temperature: 0° to 85° C

Operating Humidity: 60% RH

**Management** WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic

**Alerting** ASF 2.0 support; AMT 9.0 support



Technical Specifications - Networking and Communications

## Intel® Ethernet I210-T1 Gigabit Network Adapter

Connector RJ-45

System Interface PCI Express x1

Controller Intel® I210 Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

**Data rates supported** 10/100/1000 Mbps

**IEEE Compliance** 802.1P

802.1Q 802.2 802.3 802.3AB 802.3u

802.3x flow control

**Bus architecture** PCI-E 2.1

**Data path width** X1, 250 MB/s, Bi-directional interface

**Data transfer mode**Bus-master DMA

Hardware certifications FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union

Power requirement Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T

**Boot ROM support** Yes

10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps

Network Transfer Rate 100BASE-TX (half-duplex) 100 Mbps

100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

**Environmental** Operating Temperature: 32° to 131°F (0° to 55° C)

Operating Humidity: 85% at 131° F (55° C)

Management WOL, PXE, DMI, WFM 2.0

## Intel Centrino Advance-N 6205 Wireless Network Interface Connection

Wireless LAN Standards IEEE 802.11a/b/g/n

IEEE 802.11 e, 802.11i, 802.11d, 802.11d, 802.11h

Interoperability Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)

Tested with wireless access points from several major manufacturers

OS compatible with Microsoft Windows, Win7 and XP

Cisco Compatible Extensions Program compliant (802.11a/b/g only) with Microsoft Windows XP and

Windows 7

Frequency Band 2.4 GHz and 5 GHz

Antenna Structure 2 transmit; 2 receive (2x2)



Technical Specifications - Networking and Communications

**Data Rates** 802.11b: 1, 2, 5.5, 11 Mbps

802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of

Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n

specification

**Modulation** Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of

128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2,

LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.

**Sub-channels** Multinational support with frequency bands and channels compliant to local regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)
Intel® My Wifi Technology (iPAN)

**Roaming** Provide seamless roaming between like access points (same frequency band)

Output Power (for CCK) 15 dBm
Output Power (for OFDM; 15 dBm

power varies by data rate)

**Power Consumption** Transmit: 2.3 Watts (average, with one spatial streams)

Receive: 1.9 Watts (average with two receive chains)

Idle mode: 30mW – 40mW (average)

Radio off: 20 mW (max)

**Power Management** ACPI compliant power management

802.11 compliant power saving mode

**Antenna Connections** 3 U.FL type connectors, 50 ohm nominal impedance

Range 802.11 a - Typical (@6 Mbps) 600 feet - Outdoor Open Area

150 feet - Indoor, Office environment

802.11 b - Typical (@1 Mbps)

300 feet - Indoor, Office environment

802.11 g - Typical (@1 Mbps)

300 feet - Indoor, Office environment

CMIT & SFF: PCIe

**Weight** 0.013 lb (4.0 g)

**Dimensions** 1.1 x 1.2 in (26.8 x 30.0 mm) **Operating Voltage** 3.3V +/- 9%, 1.5V +/- 5%

**Temperature Operating:** 32° to 176° F (0° to 80° C)

**Non-operating:** -40° to 176° F (-40° to 80° C)

**Humidity Operating:** 10% to 90% (non-condensing)

**Non-operating:** 5% to 90% (non-condensing)

Microsoft Windows XP Microsoft Windows Win 7

**Form Factors** 

## **Technical Specifications - Networking and Communications**

### **Configuration Utility**

- Microsoft Windows XP Wireless Network Connection Manager
- Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support)
- Intel IHV extensions for Win7 available to support Cisco Compatible Extensions



### **Technical Specifications - Audio**

## **High Definition Audio**

**Type** Integrated

HD Stereo Codec Realtek 2-channel ALC221 codec

**Audio I/O Ports** Front microphone-In (150-K ohm Input Impedance)

Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio

driver)

Rear Line-Out\* (190 ohms Output Impedance, expects at least a 10-K ohm load)
Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load)

Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same

signal.

All ports are 3.5mm

Internal Speaker Amplifier 1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear

Line-in audio port is re-taskable as either Line-in or Microphone-In.

Multi-streaming Capable Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to

be sent to/from the front and rear jacks.

Sampling 8 kHz - 192 kHz

Wavetable Syntheses Yes – Uses OS soft wavetable

Analog Audio Yes

# of Channels on Line-Out Stereo (Left & Right channels)

Internal Speaker Yes
External Speaker Jack Yes
Full Duplex Yes



## Technical Specifications – Keyboards and Pointing Devices

## **HP USB Keyboard**

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical characteristics Dimensions (L x W x H) 18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)

Weight 2 lb (0.9 kg)

Operating voltage + 5VDC ± 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector Electrical

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

**Environmental** Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration
Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 30 in (76.2 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC



## Technical Specifications – Keyboards and Pointing Devices

Keyboard Installation Guide Kit contents

Warranty Card Safety and Comfort Guide

**HP PS/2 Keyboard** 

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical Characteristics Dimensions 18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)

 $(L \times W \times H)$ 

Weight 2 lb (0.9 kg) minimum

Operating voltage + 5VDC ± 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector **Electrical** 

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

**Mechanical** Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 50-dBA maximum sound pressure level

Operating temperature 32° to 104° F (0° to 40° C)

Non-operating temperature -22° to 149° F (-30° to 65° C)

Operating humidity 15% to 80% (non-condensing at ambient)
Non-operating humidity 15% to 90% (non-condensing at ambient)

Operating shock N/A

**Environmental** Non-operating shock 65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266

inch/second six surface

Operating vibration 2-g peak acceleration

**Key Benefits:** 

### Technical Specifications – Keyboards and Pointing Devices

Non-operating vibration Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz

and back to 5 Hz at a Logarithmic sweep rate of 1 octave per

minute.

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 29.93 in (76 cm) on concrete, 16-drop sequence

Approvals CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

**Ergonomic compliance** ANSI HFS 100, ISO 9241-4, and TUVGS

## **HP USB Smart Card (CCID) Keyboard**

Protects against unauthorized access with smart card technology

• Delivers even greater security when combined with a HP Client Security card and the HP Client

Security Software

Combination of username and password or pin with a smart card or security token

Secures online transactions using digital signatures and certificates

Conforms to industry standards for ease of setup and use

Delivers long product life and quiet operation with high-impact materials and lubricated keys

Spill drain feature

Keys 104, 105, 106, 107, 109 layout

(depending upon country

Form factor USB basic smart card keyboard

Physical Characteristics Colors Carbonite/Silver

Dimensions 18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

 $(H \times W \times D)$ 

Weight 2 lb (0.9 kg) minimum

Operating voltage + 5VDC ± 5%

Power consumption 100-mA maximum (with four LEDs ON)

Electrical System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Languages 30+ available
Keycaps Standard design

Switch actuation 55 g nominal peak force with tactile feedback

Switch life 20 million keystrokes

(using Hasco modified tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)



Mechanical

**Environmental** 

### Technical Specifications – Keyboards and Pointing Devices

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)
Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces
Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration Non-operating vibration 4-g peak acceleration

Drop 26 in (66 cm) on carpet, six-drop sequence

(out of box)

Drop 42 in (107 cm) on concrete, 16-drop sequence

(in box)

Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4 memory and

microprocessor smart cards (T=0, T=1)

Chipset SCM STCIII

Standard APIs supported PC/SC, EMV2000, CT-API

Power USB Port

Short circuit detection (protects smart card and reader)
Power supply compliant with ISO7816 and EMV (5V, 60 mA)

Supports 3-V and 5-V cards

SmartCard Function Power consumption 100-mA maximum draw

Communication From card 9600 bps to 330,000 bps

From computer 12 Mbps (USB transfer speed)

Landing mechanism Contact device Friction contact

Card insertions rating Up to 100,000 insertion cycles

Interface modes CCID protocol
Reader performance interface USB connection

Electro-magnetic standards Europe 2004/108/EC

USA USAFCC part 15

Approvals CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF

**Ergonomic Compliance** ISO 9241-4, TUVGS

**Kit Contents** Keyboard, I/O Security and Documentation CD, warranty card

## **HP USB PS/2 Washable Keyboard**

Keys 104 (US) layout or 105 (EU) layout – depending upon country

Physical Characteristics Dimensions 17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)

(L x W x H)

Weight 1.7 lb (0.77 kg) minimum

Operating voltage + 5VDC ±5%

**Electrical** 

## Technical Specifications – Keyboards and Pointing Devices

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Stepped -profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes

**Mechanical** Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 7 ft (2.2 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 95% (non-condensing at ambient)

Non-operating humidity 0% to 95% (non-condensing at ambient)

**Environmental** Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration
Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Operating system support Windows® 7, Windows Vista, Windows XP Professional

**Approvals** UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X

**Ergonomic compliance** ANSI HFS 100, ISO 9241-4, and TUVGS

## **HP Wireless Keyboard and Mouse**

Dimensions (H x L x W) 1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)

**Keyboard** Weight – Without Two AA 1.94 lb (880 g)

Alkalina Pattorias

**Alkaline Batteries** 



## Technical Specifications – Keyboards and Pointing Devices

Dimensions (H x L x W) 1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)

Mouse Weight – Without Two AA 0.15 lb (67 g)

Alkaline Batteries

Dimensions (H x L x W) 0.33 x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)

Weight 0.21 oz (5.9 g)
Receiver

Ergonomics

Cable Length – Minimum 6 ft (1.8 m)

Range 32.8 ft (10 m)

Windows 7 Home Basic\*, Windows 7 Home Premium\*, Windows 7 Professional Edition 32\*, Windows 7 Professional Edition 64\*, Windows 7 Ultimate Edition 32\*, Windows 7 Ultimate Edition

64\* Windows Vista or Windows XP Available USB port for the receiver

System Requirements CD-ROM Drive

\*This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See

ANSI; ISO (Europe only); GS Mark (Germany only)

http://www.microsoft.com/windows/windows-7/ for details.

Product Safety UL; CSA /TUV (Europe only); CE Mark; CB Report

EMC FCC; CE; ACA (-tick); BSMI; KC; VCCI

CE Mark EN 55022:2010; EN 55024; EN 301489-1; EN 61000

Design Guidelines for PCs PC 99 - connector overmold colors; PC 2001 - full functionality

Telecom All local telecom requirements and approvals for intended

markets

**Approvals** USA FCC Title 47 CFR, Par 15, Subpart C; other local requirements

Country Support US, Belgium, Switzerland, Spain, Denmark, Netherlands, France,

Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile,

Argentina, Mexico, South Africa, and up to 193 countries

worldwide.

Environmental Keyboard contains 25% post-consumer recycled plastic material

**HP PS/2 Mouse** 

**Dimensions** (H x L x W) 1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)

### Technical Specifications – Keyboards and Pointing Devices

**Weight** 3.53 oz (100g; +10g/- 5 g)

Operating temperature -32° to 104°F (0° to 40° C)

Non-operating temperature -4° to 140°F (-20° to 60° C)

Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 10% to 90%

(non condensing at ambient)

Environmental Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

Drop 80 cm height onto asphalt tile over concrete or equivalent, 5-drop

(out of box) in 5 direction except the cable face

Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector

ESD CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Resolution 800 DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration ±15%

Switch actuation 65±20 gf

MechanicalSwitch life3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 80 km

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Width 6 mm

Diameter  $22.5 \pm 0.2 \text{ mm}$ 

Maximum rotation force 50 gf-cm

Switch type Light force micro-switch

Scroll wheel

**Electrical** 

## Technical Specifications – Keyboards and Pointing Devices

Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

**Regulatory Approvals** UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick

### **HP USB Mouse**

**Dimensions** (H x L x W)

1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)

**Weight** 0.22 lb (0.10 kg)

Cable length 70.9 in (180 cm)

**System requirements** Available USB port

## **HP USB 1000dpi Laser Mouse**

**Dimensions** 1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)

(HxLxW)

**Weight** 3.360 oz (102g)

Cable length 70.9 in (180 cm)

**System requirements** Available USB port

Operating Temperature 32° to 104° F (0° to 40° C)

**Environmental** Non-operating Temperature -4° to 140° F (-20° to 60° C)

Operating Humidity 10% to 90%

(non-condensing at ambient)

Resolution 1000dpi

**Mechanical** Tracking Speed 45 cm/sec

Cable Length 70.9 in (180 cm)



## Technical Specifications – Keyboards and Pointing Devices

### **HP USB PS/2 Washable Mouse**

**Dimensions** (H x L x W) 1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)

**Weight** 4.44 oz (126 g)

Operating temperature -32° to 104°F (0° to 40° C) Non-operating -4° to 140°F (-20° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 10% to 90% non-condensing

**Environmental** Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces
Operating vibration 2 g peak acceleration
Non-operating vibration 4 g peak acceleration

Drop (out of box) 80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5

direction except the cable face

Operating voltage 5 VDC ± 10% Power consumption 100mA

Electrical System consumption PS/2 mini-din connector or USB

ESD CE level 2 8 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC99 – 2001 Functionally compliant Resolution 1000 ± 20% DPI

Tracking speed 14 in/s (35.56 cm/s) maximum

Acceleration 2 g

Mechanical Switch actuation 70 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches
Cable length 8.8 ft total 70 cm+ 2m extension

Microsoft PC99 – 2001 Mechanically compliant

Width 6 mm

Diameter 1 in (25.4 mm)
Maximum rotation speed 48 rats/sec

Scroll wheel

Switch type

Light force micro-switch
Switch life

3 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant FCC, CE Mark, ICES-003-B, IP66/NEMA4X



## Technical Specifications - Power

## **Unit Environment and Operating Conditions**

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is
  operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)\*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Altitude Operating: 10,000 ft (3048 m) (unpressurized) Non-operating: 30,000 ft (9144 m)

<sup>\*</sup>Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	DM	SFF	TWR
Standard Efficiency	65W active PFC 87% efficient	240W active PFC	320W active PFC
80 PLUS Gold	N/A	240W active PFC	320W active PFC
		87/90/87% efficient at 20/50/100% load (115V)	87/90/87% efficient at 20/50/100% load (115V)
		89/91/90% efficient at 20/50/100% load (230V)	89/92/90% efficient at 20/50/100% load (230V)
80 PLUS Platinum	N/A	240W active PFC	320W active PFC
		90/92/89% efficient at 20/50/100% load (115V)	90/92/89% efficient at 20/50/100% load (115V)
		90/93/91% efficient at 20/50/100% load (230V)	90/94/91% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 240 VAC	100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 - 63 Hz	47 - 63 Hz	47 - 63 Hz
Rated Input Current	N/A	4A	5.5A



<b>Technical Specifications</b>	s – Power		
Rated Input Current with Energy Efficient* Power Supply	ТВА	4A	5.5A
DC Output	+19.5V		
Current Leakage (NFPA 99)	< 250 μΑ	< 275 μΑ	<450=>275uA
Power Supply Fan	N/A	92=>70mm variable speed	92mm variable speed
Power cord length	N/A	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
External Power Adapter			
Dimensions	2.2 x 1.2 x 4.5 in 55 x 30 x 113.5 mm	N/A	N/A
Total Cord Length	12 ft. 8 in	N/A	N/A

<sup>\*</sup>High efficiency power supply is a requirement for ENERGY STAR® qualification in conjunction with a select range of processors and modules



Technical Specifications – Weights & Dimensions

## **Weights & Dimensions**

(configured with 1 HDD & 1 ODD)

	DM	SFF	TWR
Chassis (W x H x D)	6.9 x 1.3 x 7.0 in	13.3 x 3.95 x 14.9 in	6.7 x 15.7 x 17.4 in
	175 x 34 x 177 mm	338 x 100 x 379 mm	170 x 399 x 442 mm
System Volume	62.79 cu in	782.7 cu in	1828 cu in
	1.05 L	12.8 L	30 L
System Weight	2.9 lb	16.7 lb	20.5 lb
	1.3 kg	7.6 kg	9.3 kg
Max Supported Weight (desktop orientation)	N/A	77.0 lb 35.0 kg	77.0 lb 35.0 kg
Stand Dimensions	.77x 4.6 x 6.3 in 19.5 x 117 x 160 mm Weight: 47g/ .1 lbs.	1.1 x 7.0 x 7.9 in 29 x 178 x 200 mm	N/A
Packaging	7.8 x 11.4 x 19.7 in	9.0 x 19.7 x 23.4 in	11.6 x 19.7 x 23.2 in
	198 x 290 x 500 mm	229 x 500 x 594 mm	295 x 500 x 590 mm
Shipping Weight	9.0 lb.	17.9 lb	28.8 lb
	4.1 kg	8.1 kg	13.1 kg
Palletization Profile	8-units per layer	4-units per layer	4-units per layer
	10/12 layer max	10-layer max.	8-layer max.
	80/96 per pallet	40-units per pallet	32-units per pallet

(Dependent on 40-Ft Stnd. Sea Container or 40-Ft High-cube Sea Container is used)



## Technical Specifications – Miscellaneous Features

### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls
  system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state
  without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

## Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - O Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
    - 2 processor thermal protection activated
    - 3 processor not installed
    - 4 power supply failure
    - 5 -- memory error
    - 6 video error
    - 7 PCA failure (ROM detected failure prior to video)
    - 8 invalid ROM, bootblock recovery mode
    - 9 system not fetching code
    - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
  - O This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacemen
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



### Technical Specifications – Miscellaneous Features

**Towerable Orientation** Product can be oriented as either a desktop or a tower

Implementation of the industry standard ATA Security feature set. When enabled, it **Drive Lock** 

prevents software access to user data on the drive until one or two user-defined

passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector of

the hard drive for physical faults and then reports any faults to the user

Running independently of the operating system, it can be accessed through a Windowsbased diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be

replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types

of failures

SMART Technology (Self-Monitoring, Allows hard drives to monitor their own health and to raise flags if imminent failures were Analysis and Reporting Technology)

predicted

Predicts failures before they occur. Tracks fault prediction and failure indication SMART I - Drive Failure Prediction

parameters such as re-allocated sector count, spin retry count, calibration retry count

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against **SMART II - Off-Line Data Collection** 

unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with

**Defect Reallocation** 

**Drive Protection System** 

IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives Interface in F10 setup provides confirmation of SMART IV support.



## Technical Specifications - Environmental Data

### **Environmental Data**

Eco-Label
Certifications
& Declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT Gold where HP registers commercial desktop products. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status in your country.

\*NOTE: This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.

## **Desktop Mini**

**System Configuration** 

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

### Energy Consumption (in accordance with US ENERGY STAR® test method)

Normal Operation
Sleep
Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
7.61W	7.70W	7.60W
1.42W	1.44W	1.42W
0.93W	0.96W	0.93W

### **NOTE:**

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	26 BTU/hr	26 BTU/hr	26 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Sound Pressure

### Technical Specifications – Environmental Data

Declared Noise Emissions	
(in accordance with	
ISO 7779 and ISO 9296)	
Typically Configured - Idle	

(LWAd, bels)	(LpAm, decibels)
3.6	25
3.6	25

## Fixed Disk - Random writes Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

10 externally accessible USB ports

Sound Power

- 4 DIMM memory slots
- 1 PCI Express x16 graphics slot
- 3 PCI Express x1 accessory slots
- 1 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay (could also support an internal storage drive)
- 1 external slim optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### **Batteries**

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

115VAC. 60Hz

Battery type: Lithium

### **Additional Information**

Pending

## Small Form Desktop

### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

230VAC. 50Hz

### Energy Consumption (in accordance with US ENERGY STAR® test method)

Normal Operation	21.00 W	21.05 W	21.42 W
Sleep	1.42 W	1.50 W	1.42 W
Off	0.50 W	0.57 W	0.50 W

#### NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.



100VAC. 60Hz

### Technical Specifications – Environmental Data

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	72 BTU/hr	72 BTU/hr	73 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr

<sup>\*</sup>NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

### Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

Typically Configured - Idle Fixed Disk - Random writes

#### **Longevity and Upgrading**

Sound Power	Sound Pressure
(LWAd, bels)	(LpAm, decibels)
3.6	26
3.6	26

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 externally accessible USB ports
- 4 DIMM memory slots
- 1 PCI Express x16 graphics slot
- 3 PCI Express x1 accessory slots
- 1 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay (could also support an internal storage drive)
- 1 external slim optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

### **Batteries**

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

#### **Additional Information**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 14.8 % post-consumer recycled plastic (by wt.)
- This product is 94.1 % recycle-able when properly disposed of at end of life.



## Technical Specifications - Environmental Data

#### **Packaging Materials**

- External:
  - O PAPER/Corrugated 2300 g
- Internal:
  - O PLASTIC/Polyethylene low density 56 g
  - O PLASTIC/EPE-Expanded Polyethylene 110 g
  - O PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material contains at least 38.4 % recycled content.
- The PLASTIC/Polyethylene low density packaging material contains at least 60.4% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene packaging material contains at least 60.4% recycled content.
- The PLASTIC/Polyethylene packaging material contains at least 60.4 % recycled content.

### **Tower**

### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Tower model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

### Energy Consumption (in accordance with US ENERGY STAR® test method)

Normal Operation
Sleep
Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
22.49 W	23.72 W	22.22 W
1.42 W	1.50 W	1.39 W
0.47 W	0.56 W	0.46 W

#### **NOTE:**

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	77 BTU/hr	81 BTU/hr	76 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr

**\*NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

### Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

Typically Configured - Idle Fixed Disk - Random writes

**Longevity and Upgrading** 

Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
3.6	26
3.6	26

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:



### Technical Specifications – Environmental Data

- 10 externally accessible USB ports
- 4 DIMM memory slots
- 1 PCI Express x16 graphics slot
- 3 PCI Express x1 accessory slots
- 2 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay
- 1 external slim optical drive bay
- 1 external 5.25" half height optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### **Batteries**

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

#### **Additional Information**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 15 % post-consumer recycled plastic (by wt.)
- This product is 95.5 % recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

- External:
  - PAPER/Corrugated 2280 g
- Internal:
  - PLASTIC/EPE (Expanded Polyethylene) 40 g
  - PLASTIC/Polyethylene low density 144 q
  - PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material contains at least 53.5 % recycled content
- The PLASTIC/Polyethylene low density packaging material contains at least 60.42 % recycled content
- The PLASTIC/EPE-Expanded Polyethylene packaging material contains at least 60.42 % recycled content.
- The PLASTIC/Polypropylene packaging material contains at least 60.42 % recycled content.

### Common to all Form Factors



### Technical Specifications – Environmental Data

### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmiun
- Chlorinated Hydrocarbons Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### **ALL FORM FACTORS ARE UL CERTIFIED**

### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

### Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report



## Technical Specifications – Environmental Data

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label certifications** 

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/

PC\_GBU\_Product\_Design\_ISO\_14K\_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Options and Accessories (sold separately)

Communication Devices	DM	SFF/TWR	Part Number
Intel Ethernet I210 - T1 Gbe NIC		Χ	E0X95AA
Intel 6205 802.11 a/b/g/n PCIe x1 NIC		Χ	E0X93AA
NOTE: The use of any of those estimated NIC Could (vived on viveless) will disable the lately of	Dua Taaba	alaan faatuwaa	

**NOTE:** The use of any of these optional NIC Cards (wired or wireless) will disable the Intel vPro Technology features.

Graphics Solutions	DM	SFF/TWR	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)		Х	E1C63AA
AMD Radeon HD 8490 Graphics Card		Χ	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)		Χ	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)		Χ	E1C65AA
HP USB Graphic Adapter		Χ	NL571AA
HP DisplayPort Cable Kit	Х	Χ	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	Х	Χ	NR078AA
HP DisplayPort To DVI-D Adapter	Х	Χ	FH973AA
HP DisplayPort to HDMI Adapter	Х	Χ	BP937AA
HP DisplayPort to VGA Adapter	Х	Χ	AS615AA
HP DMS-59 to Dual DVI Cable		Χ	DL139A
HP DMS-59 to Dual DisplayPort Adapter		Х	XP688AA

vata Storage vrives and Accessories	DM	SFF/TWR	Part Number
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		Χ	QK554AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		Χ	QK555AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	Х	Χ	QV063AA
HP 128-GB SED Opal 2 Solid State Drive	Х		G1K24AA
HP 160-GB SATA 3.0Gb/s Solid State Drive	Х	Χ	QV064AA*
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	Х	Χ	E1C62AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)		Χ	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)		Χ	E3F39AA
HP Chassis (1bay) Security Kit		TWR only	AR639AA

<sup>\*</sup>Not available in all regions.



Options and Accessories (sold separately)

Input Devices	DM	SFF/TWR	Part Number
HP USB Keyboard	Х	Χ	QY776AA
HP USB Gray Keyboard	Х	Χ	B6B64AA
HP USB Smart Card (CCID) Keyboard	Х	Χ	BV813AA
HP USB Keyboard and Mouse Kit	Χ	Χ	B1T09AA
HP USB Washable Keyboard	Χ	Χ	VF097AA
HP USB and PS/2 Washable Mouse	Χ	Χ	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	Х	Χ	BU207AA
HP PS/2 Mouse		Χ	QY775AA
HP USB Mouse	X	Χ	QY777AA
HP USB 1000dpi Laser Mouse	Χ	Χ	QY778AA
HP Wireless Keyboard and Mouse Combination*	Χ	Χ	QY449AA
*Keyboard contains 25% post-consumer recycled plastic material			
System Memory	DM	SFF/TWR	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM		Χ	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM		Χ	B4U37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	Х		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	Х		B4U40AA
Multimedia Devices	DM	SFF/TWR	Part Number
HP Slim DVD-ROM Drive		Χ	VP033AA
HP Slim SuperMulti DVD Writer Drive		Χ	QS209AA
HP USB HD 720P v2 Business Webcam	Х	Χ	D8Z08AA
HP Business Headset	Х	Χ	QK550AA
HP USB Business Speakers	Х	Х	D9J19AA
Removable Media Storage	DM	SFF/TWR	Part Number
HP 14-n-1 Media Card Reader (available Dec. 2013)		Х	TBD
Security Devices	DM	SFF/TWR	Part Number
HP Solenoid Lock and Hood Sensor (SFF)		SFF only	E0X97AA
HP Solenoid Lock and Hood Sensor (TWR)		TWR only	E0X96AA
HP SFF Wall Mount/Security Sleeve		SFF only	VN570AA
HP UltraSlim Cable Lock	Х	Х	H4D73AA



Options and Accessories (sold separately)

LANDesk Software (E-Delivery)

Stands and Accessories	DM	SFF/TWR	Part Number
HP Integrated Work Center - Desktop Mini / Thin Client (IWCdm)	Х		
HP Integrated Work Center Stand (SFF)		SFF only	QP897AA
HP SFF Tower Stand		SFF only	VN569AA
HP DM Chassis Tower Stand	Х		G1K23AA
HP 600/800 Tower Bezel Kit		TWR only	E1C66AA
HP 800/600 SFF Bezel Kit		SFF only	E3F27AA
HP Serial Port Adapter (RS-232 compatible)		Χ	PA716A
HP Parallel Port Kit		Χ	KD061AA
Belkin USB to Serial Adapter	Х		EM449AA

#### LANDesk Management Suite License - 1-499 Nodes E-Delivery QY369AAE LANDesk Management Suite License - 500-999 Nodes E-Delivery QY370AAE LANDesk Management Suite License - 1000-1999 Nodes E-Delivery QY371AAE LANDesk Management Suite License - 2000-4999 Nodes E-Delivery QY372AAE LANDesk Management Suite License - 5000-9999 Nodes E-Delivery OY373AAE LANDesk Security Suite License E-Delivery QY379AAE LANDesk Management Suite 1 Year Maintenance - 1-499 Nodes E-Delivery HZ825AAE LANDesk Management Suite 1 Year Maintenance - 500-999 Nodes E-Delivery HZ826AAE LANDesk Management Suite 1 Year Maintenance - 1000-1999 Nodes E-Delivery HZ827AAE LANDesk Management Suite 1 Year Maintenance - 2000-4999 Nodes E-Delivery HZ828AAE LANDesk Management Suite 1 Year Maintenance - 5000-9999 Nodes E-Delivery HZ829AAE HZ830AAE LANDesk Security Suite 1 Year Subscription LANDesk Patch Management 1 Year Subscription - 1-499 Nodes E-Delivery HZ831AAE

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LANDesk Patch Management 1 Year Subscription - 500-999 Nodes E-Delivery

LANDesk Patch Management 1 Year Subscription - 1000-1999 Nodes E-Delivery

LANDesk Patch Management 1 Year Subscription - 2000-4999 Nodes E-Delivery

LANDeskPatch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery

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**Part Number** 

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